## Programmable Peripheral Interface iAPX86 Family MILITARY INFORMATION

## DISTINCTIVE CHARACTERISTICS

- SMD/DESC qualified
- Direct bit set/reset capability easing control application interface
- Reduces system package count
- Improved DC driving capability

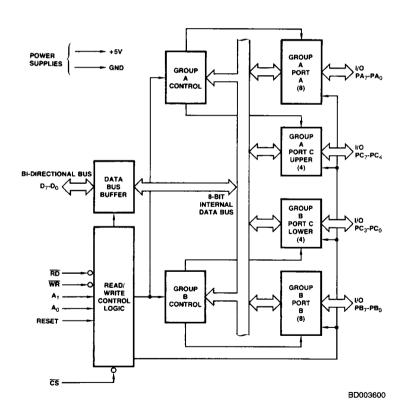
- 24 programmable I/O pins
- Completely TTL-compatible
- Fully compatible with the iAPX86 microprocessor family
- Improved timing characteristics

## **GENERAL DESCRIPTION**

The 8255A is a general-purpose, programmable I/O device designed for use with iAPX Family microprocessors. It has 24 I/O pins which may be individually programmed in two groups of twelve, and used in three major modes of operation. In the first mode, each group of twelve I/O pins may be programmed in sets of four and eight to be input or output. In Mode 1, the second mode, each group may be

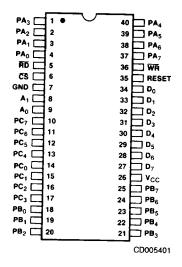
programmed to have eight lines of input or output. Of the remaining four pins, three are used for handshaking and interrupt control signals. The third mode of operation (Mode 2) is a bidirectional bus mode which uses eight lines for a bidirectional bus, and five lines, borrowing one from the other group, for handshaking.

### **BLOCK DIAGRAM**



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# CONNECTION DIAGRAM Top View



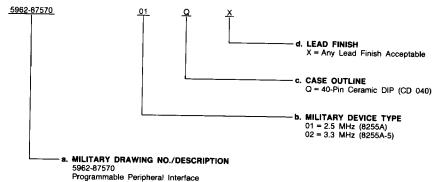
Note: Pin 1 is marked for orientation.

## MILITARY ORDERING INFORMATION

## Standard Military Drawing (SMD)/DESC Products

AMD products for Aerospace and Defense applications are available in several packages and operating ranges. Standard Military Drawing (SMD)/DESC products are fully compliant with MIL-STD-883C requirements. The order number (Valid Combination) for SMD/DESC products is formed by a combination of: a. Military Drawing Part Number

- b. Device Type
- c. Case Outline
- d. Lead Finish



# Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations or to check for newly released valid combinations.

#### Group A Tests

Group A tests consist of Subgroups 1, 2, 3, 7, 8, 9, 10, 11.

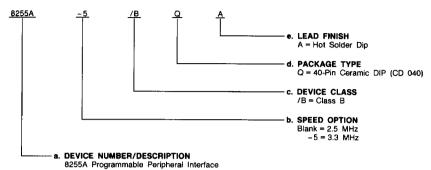
Valid Combinations				
5962-8757001				
5962-8757002	QX			

## MILITARY ORDERING INFORMATION (Cont'd.)

**APL Products** 

AMD products for Aerospace and Defense applications are available in several packages and operating ranges. APL (Approved Products List) products are fully compliant with MIL-STD-883C requirements. The order number (Valid Combination) for APL products is formed by a combination of: a. Device Number

- b. Speed Option (if applicable)
- c. Device Class
- d. Package Type
- e. Lead Finish



#### **Valid Combinations**

Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations or to check for newly released valid combinations.

#### **Group A Tests**

Group A tests consist of Subgroups 1, 2, 3, 7, 8, 9, 10, 11.

Valid Combinations					
8255A	/BOA				
8255A-5					

## ABSOLUTE MAXIMUM RATINGS

Storage Temperature65 to	+ 150°C
V <sub>CC</sub> with Respect to V <sub>SS</sub> 0.5 t	0 70 V
All Signal Voltages	
with Respect to VSS0.5 to	+7.0 V
Power Dissipation	10.14

Stresses above those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent device failure. Functionality at or above these limits is not implied. Exposure to absolute maximum ratings for extended periods may affect device reliability.

## **OPERATING RANGES**

Military (M) Devices			
Temperature (TC)55	to	1	25°C
Supply Voltage (V <sub>CC</sub> )5	٧	±	10%

Operating ranges define those limits between which the functionality of the device is guaranteed.

**DC CHARACTERISTICS** over operating range (for SMD/DESC and APL Products, Group A, Subgroups 1, 2, 3 are tested unless otherwise noted)

Parameter Symbol	Parameter Description	Test Conditions	Min.	Max.	Unit
V <sub>IL</sub> †	Input Low Voltage	V <sub>CC</sub> = 4.5 V	-0.5 *	0.8	- V
V <sub>IH</sub> †	Input High Voltage	V <sub>CC</sub> = 5.5 V	2.2	5.5*	<u>v</u>
V <sub>OL</sub> (DB)	Output Low Voltage (Data Bus)	I <sub>OL</sub> = 2.5 mA, V <sub>CC</sub> = 5.5 V	2.2	<del></del>	<u>v</u>
V <sub>OL</sub> (PER)	Output Low Voltage (Peripheral Port)	I <sub>OL</sub> = 1.7 mA, V <sub>CC</sub> = 5.5 V		0.45	
V <sub>OH</sub> (DB)	Output High Voltage (Data Bus)	I <sub>OH</sub> = -400 μA, V <sub>CC</sub> = 45	24	0.45	
V <sub>OH</sub> (PER)	Output High Voltage (Peripheral Port)	I <sub>OH</sub> = -200 crA, <sub>CC</sub> = 4			<u>v</u>
IDAR	Darlington Drive Current (Note 1)	Re = 7.0 % Ext = 1. V	2.4		v
lcc			-1.0	-4.0	mA
lil.	Input Load Current	YCC USY		120	mA
	<del>                                     </del>	= V <sub>CC</sub> 10 0 V, V <sub>CC</sub> = 5.5 V		±10	μΑ
OFL	Output Part Callage	Vout = VCC to 0 V, VCC = 5.5 V		±10	μΑ

## CAPACITANCE TO SEC SOND = 0 V

Parameter Symbol	Parameter Description	Test Conditions	Min.	Тур.	Max.	Unit
CINTT	Input Capacitance	fc = 1 MHz			15*	
CI/Ott	I/O Capacitance	Unmeasured pins returned to GND			25*	pF pF

\*Guaranteed by design; not tested.

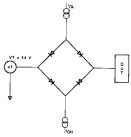
†Group A, Subgroups 9, 10, 11 only are tested.

††Not included in Group A tests.

Notes: 1. Available on any 8 pins from Port B and C.

2. ICC test conditions: the supply current is measured with loaded outputs while running AC patterns.

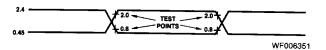
## SWITCHING TEST CIRCUIT



TC003850

This test circuit is the dynamic load of a Teradyne J941.

#### SWITCHING TEST WAVEFORM



AC testing: Inputs are driven at 2.4 V for a logic "1" and 0.45 V for a logic "0." Timing measurements are made at 2.0 V for a logic "1" and 0.8 V for a logic "0."

**SWITCHING CHARACTERISTICS** over operating range (for SMD/DESC and APL Products, Group A, Subgroups 9, 10, 11 are tested unless otherwise noted) (Note 1)

### **BUS PARAMETERS**

Daramata	Parameter	ameter Parameter	82	8255A		8255A-5	
No. Symbol		Description	Min.	Max.	Min.	Max.	Unit
REA	D				-	-	
1	tAR	Address Stable Before READ	0		0		ns
2	tRA	Address Stable After READ	0		0		ns
3	t <sub>RR</sub>	READ Pulse Width	300		300		ns
4	t <sub>RD</sub>	Data Valid From READ (Note 1)		250		200	ns
5	t <sub>DF</sub>	Data Float After READ (Note 3)	10	150	10	100	ns
6	t <sub>RV</sub>	Time Between READs and/or WRITEs	850		850		ns
WRI	TE			-			
7	taw	Address Stable Before WRITE	0		0		ns
8	twa	Address Stable After WRITE	20		20		ns
9	tww	WRITE Pulse Width	400		300		ns
10	t <sub>DW</sub>	Data Valid to WRITE (T.E.)	300	1	100		ns
11	two	Data Valid After WRITE	<b>1</b> 36		30		ns
ОТН	ER TIMINGS	4	4				
12	twB	WR = 1 to Output (Note 1)	<b>A</b>	350		350	ns
13	tiR	Peripheral Data Before RD	0		0		ns
14	tHR	Peripheral Data After RD	0		0		ns
15	t <sub>AK</sub>	ACK Pulse Width	300		300		ns
16	tsт	STB Pulse Width	500		500		ns
17	tps	Per. Data Before E. of JB	0		0		ns
18	t <sub>PH</sub>	Per. Data A E. STB	180		180		ns
19	t <sub>AD</sub>	ACK = to that (Note 1)		300		300	ns
20	t <sub>KD</sub>	ACK = 1 to Sutput Float (Note 3)	20	250	20	250	ns
21	twoв	WR = 1 to OBF = 0 (Note 1)		650		650	ns
22	t <sub>AOB</sub>	ACK = 0 to OBF = 1 (Note 1)		350		350	ns
23	tsib	STB = 0 to IBF = 1 (Note 1)		300		300	ns
24	tRIB	RD = 1 to IBF = 0 (Note 1)		300		300	ns
25	tRIT	RD = 0 to INTR = 0 (Note 1)		400		400	ns
26	tsit	STB = 1 to INTR = 1 (Note 1)		300		300	ns
27	<sup>t</sup> AIT	ACK = 1 to INTR = 1 (Note 1)		350		350	ns
28	twiT	WR = 1 to INTR = 0 (Note 1)		450		450	ns

Notes: 1. Test Conditions:  $V_{CC} = 5.5 \text{ V}$  and 4.5 V,  $V_{IH} = 2.4 \text{ V}$ ,  $V_{IL} = .45 \text{ V}$ ,  $V_{OH} = 2.0 \text{ V}$ ,  $V_{OL} = .8 \text{ V}$ ,  $C_L = 100 \text{ pF} \pm 20 \text{ pF}$ .

<sup>2.</sup> Period of Reset pulse must be at least 50  $\mu$ s during or after power on. Subsequent Reset pulse can be 500 ns min.

<sup>3.</sup> AC float timing parameters tDF and tKD are tested Logic 0 to float only.